

MP7541B 15 V CMOS Multiplying 12-Bit Digital-to-Analog Converter

### FEATURES

- ESD Protection: 2000 V Minimum
- Full Four Quadrant Multiplication
- Low Glitch Energy
- 12-Bit Linearity (End-Point)
- Guaranteed Monotonic. All Grades. All Temperatures.
- TTL/5 V CMOS Compatible
- Stable, More Accurate Segmented Architecture
- 2.0 ppm/°C Typ. Gain Error Tempco
- 0.2 ppm/°C Max. Linearity Tempco
- Lowest Sensitivity to Output Amplifier Offset
- Latch-Up Free

### **APPLICATIONS**

- Industrial Automation
- Automatic Test Equipment
- Disk Drive Servo Systems
- Digital/Synchro Conversion
- Programmable Gain Amplifiers
- Ratiometric A/D Conversion
- Function Generation
- Digitally Controlled Filters

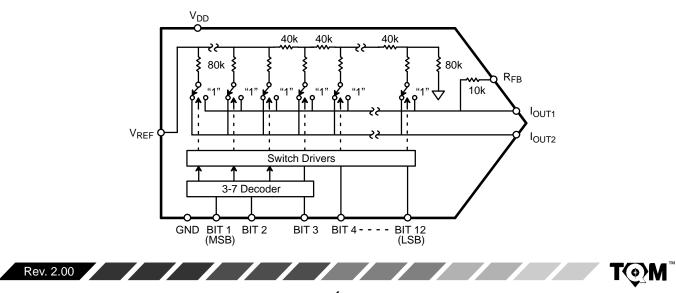
## **GENERAL DESCRIPTION**

The MP7541B is a pin-compatible replacement which offers superior performance in latch-up and ESD protection versus the comparable 7541 and 7541A. The high ESD protection will reduce failures caused by mishandling. These devices are manufactured using patented advanced thin film resistors on a double metal CMOS process which result in ultra stable thin film and superior long life reliability and stability. The MP7541B incorporates a bit decoding technique yielding lower glitch, higher speed and excellent accuracy over temperature and time. The MP7541B's outstanding features are:

Stability: Both Integral Non-Linearity (INL) and Differential-Non-Linearity (DNL) are rated at 0.2 ppm/°C maximum. Monotonicity is guaranteed over the entire temperature range. Gain Temperature Coefficient (TCGE) is 2.0 ppm/°C typical.

Lower Sensitivity to Output Amplifier Offset: Multiplying DACs provide an output current into a virtual ground of the output op amp. Additional linearity error caused by the op amp is reduced by a factor of 3 in the MP7541B versus conventional R-2R DACs.

### SIMPLIFIED BLOCK DIAGRAM



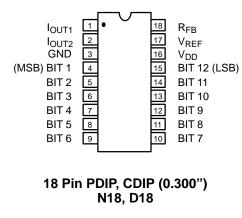
# **ORDERING INFORMATION**

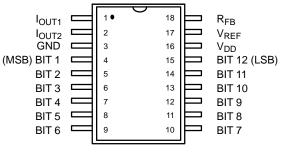
Package Type	Temperature Range	Part No.	INL (LSB)	DNL (LSB)	Gain Error (LSB)
Plastic Dip	–40 to +85°C	MP7541BKN	±1/2	±1/2	±5
Plastic Dip	–40 to +85°C	MP7541BJN	±1	±1	±8
SOIC	–40 to +85°C	MP7541BKS	±1/2	±1/2	±5
SOIC	–40 to +85°C	MP7541BJS	±1	±1	±8
Ceramic Dip	–55 to +125°C	MP7541BTD*	±1/2	±1/2	$\pm 5$
Ceramic Dip	–55 to +125°C	MP7541BSD*	±1	±1	±8

\*Contact factory for non-compliant military processing

# **PIN CONFIGURATIONS**

See Packaging Section for Package Dimensions





### 18 Pin SOIC (Jedec, 0.300") S18

# **PIN OUT DEFINITIONS**

PIN NO.	NAME	DESCRIPTION		PIN NO.	NAME	DESCRIPTION		
1	I <sub>OUT1</sub>	Current Output 1		10	BIT 7	Data Input Bit 7		
2	I <sub>OUT2</sub>	Current Output 2		11	BIT 8	Data Input Bit 8		
3	GND	Ground		12	BIT 9	Data Input Bit 9		
4	BIT 1	Data Input Bit 1 (MSB)		13	BIT 10	Data Input Bit 10		
5	BIT 2	Data Input Bit 2		14	BIT 11	Data Input Bit 11		
6	BIT 3	Data Input Bit 3		15	BIT 12	Data Input Bit 12 (LSB)		
7	BIT 4	Data Input Bit 4		16	V <sub>DD</sub>	Positive Power Supply		
8	BIT 5	Data Input Bit 5		17	V <sub>REF</sub>	Reference Input Voltage		
9	BIT 6	Data Input Bit 6		18	R <sub>FB</sub>	Internal Feedback Resistor		
Rev. 2	Rev. 2.00 T⊙M <sup>™</sup>							



# **ELECTRICAL CHARACTERISTICS**

 $V_{DD}$  = + 15 V,  $V_{REF}$  = +10 V,  $I_{OUT1}$  =  $I_{OUT2}$  = GND = 0 V Unless Otherwise Noted.

Parameter	Symbol	Min	25 <sup>°</sup> С Тур	Max	Tmin to Min	Tmax Max	Units	Test Conditions/Comments
STATIC PERFORMANCE <sup>1</sup>								
Resolution (All Grades)	Ν	12			12		Bits	
Integral Non-Linearity (Relative Accuracy) K, T J, S	INL			<u>+</u> 1/2 <u>+</u> 1		<u>+</u> 1/2 <u>+</u> 1	LSB	End Point Linearity
Differential Non-Linearity K, T J, S	DNL			<u>+</u> 1/2 <u>+</u> 1		<u>+</u> 1/2 <u>+</u> 1	LSB	All grades monotonic over full temperature range.
Gain Error K, T J, S	GE			<u>+</u> 3 <u>+</u> 6		<u>+</u> 5 <u>+</u> 8	LSB	Using Internal R <sub>FB</sub>
Gain Temperature Coefficient <sup>2</sup>	$TC_{GE}$					<u>+</u> 2	ppm/°C	$\Delta$ Gain/ $\Delta$ Temperature
Power Supply Rejection Ratio	PSRR		5	<u>+</u> 50		<u>+</u> 100	ppm/%	$ \Delta Gain/\Delta V_{DD} $ $\Delta V_{DD} = \pm 5\%$
Output Leakage Current	I <sub>LKG</sub>		5	<u>+</u> 10		<u>+</u> 200	nA	Digital Inputs = 0 or 5 V
DYNAMIC PERFORMANCE <sup>2</sup>								RL=100Ω, C <sub>EXT</sub> =13pF
Current Settling Time	ts		0.65	1.0			μs	Full scale change to 1/2 LSB
AC Feedthrough at I <sub>OUT1</sub>	F <sub>T</sub>		1.0				mV p-p	V <sub>REF</sub> = 20 V p-p 10kHz, Sinewave
Glitch Energy	Egl		500				nVs	000 to 111
Propagation Delay	t₽D		60				ns	Input Change From 50% of digital input to 10% of final analog output current
REFERENCE INPUT								
Input Resistance	R <sub>IN</sub>	5	10	20	5	20	kΩ	
DIGITAL INPUTS								
Logical "1" Voltage Logical "0" Voltage Input Leakage Current Input Capacitance <sup>2</sup> Data	V <sub>IH</sub> V <sub>IL</sub> I <sub>INH</sub> , I <sub>INL</sub> C <sub>IN</sub>	3.0	2.4	0.8 <u>+</u> 1.0 8.0	3.0	0.8 <u>+</u> 1.0 8.0	V V μA pF	
ANALOG OUTPUTS <sup>2</sup>								
Output Capacitance	C <sub>OUT1</sub> C <sub>OUT1</sub> C <sub>OUT2</sub> C <sub>OUT2</sub>		100 50 50 100				pF pF pF pF	DAC all 1's DAC all 0's DAC all 1's DAC all 0's
POWER SUPPLY <sup>3</sup>								
Functional Voltage Range <sup>2</sup> Supply Current	V <sub>DD</sub> I <sub>DD</sub>	4.5		16 1.0	4.5	16 1.0	V mA	All Digital Inputs = 0 or 5 V







# ELECTRICAL CHARACTERISTICS (CONT'D)

#### NOTES:

- <sup>1</sup> Full Scale Range (FSR) is 10V for unipolar mode.
- <sup>2</sup> Guaranteed but not production tested.
- <sup>3</sup> Specified values guarantee functionality. Refer to other parameters for accuracy.

Specifications are subject to change without notice

## ABSOLUTE MAXIMUM RATINGS (TA = +25°C unless otherwise noted)<sup>1, 2</sup>

V <sub>DD</sub> to GND	0 to +17 V
Digital Input Voltage to GND	GND -0.5 to V <sub>DD</sub> +0.5 V
I <sub>OUT1</sub> , I <sub>OUT2</sub> to GND	GND -0.5 to V <sub>DD</sub> +0.5 V
V <sub>REF</sub> to GND	<u>+</u> 25 V
V <sub>RFB</sub> to GND	<u>+</u> 25 V

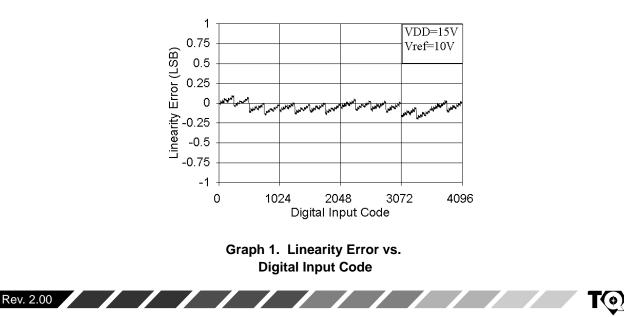
Storage Temperature65°C to -	+150°C
Lead Temperature (Soldering, 10 seconds)	+300°C
Package Power Dissipation Rating to 75°C	
CDIP, PDIP, SOIC	350mW
Derates above 75°C 11	mW/°C

### NOTES:

- Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
- Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies. *All inputs have protection diodes* which will protect the device from short transients outside the supplies of less than 20mA for less than 100µs.

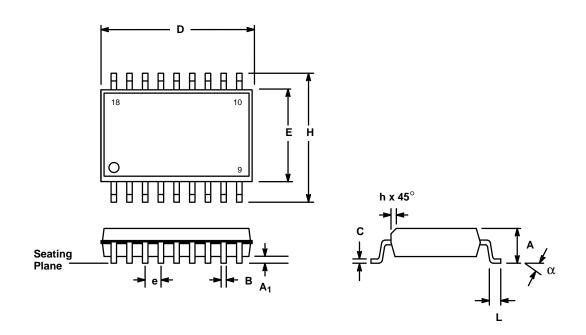
### APPLICATION NOTES Refer to Section 8 for Applications Information

# PERFORMANCE CHARACTERISTICS







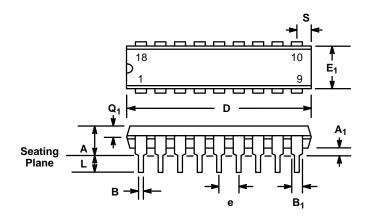


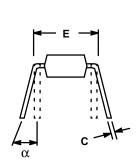
	INC	CHES	MILLIMETERS		
SYMBOL	MIN	MAX	MIN	MAX	
А	0.097	0.104	2.464	2.641	
A <sub>1</sub>	0.0050	0.0115	0.127	0.292	
В	0.014	0.019	0.356	0.483	
С	0.0091	0.0125	0.231	0.318	
D	0.451	0.461	11.46	11.71	
E	0.292	0.299	7.42	7.59	
е	0.0	50 BSC	1.2	7 BSC	
н	0.400	0.410	10.16	10.41	
h	0.010	0.016	0.254	0.406	
L	0.016	0.035	0.406	0.889	
α	0°	8°	0°	8°	





# 18 LEAD PLASTIC DUAL-IN-LINE (300 MIL PDIP) N18





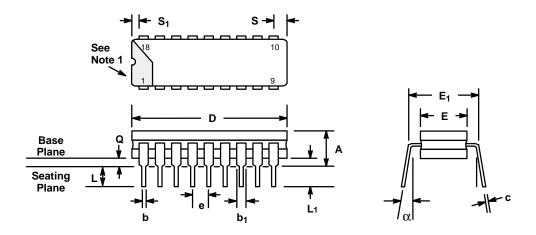
	INC	HES	MILLIN	<b>IETERS</b>
SYMBOL	MIN	MAX	MIN	MAX
А	_	0.200		5.08
A <sub>1</sub>	0.015		0.38	
В	0.014	0.023	0.356	0.584
B <sub>1</sub> (1)	0.038	0.065	0.965	1.65
С	0.008	0.015	0.203	0.381
D	0.845	0.925	21.46	23.50
E	0.295	0.325	7.49	8.26
E <sub>1</sub>	0.220	0.310	5.59	7.87
е	0.1	00 BSC	2.5	4 BSC
L	0.115	0.150	2.92	3.81
α	0°	15°	0°	15°
Q <sub>1</sub>	0.055	0.070	1.40	1.78
S	0.040	0.098	1.02	2.49

Note: (1) The minimum limit for dimensions B1 may be 0.023" (0.58 mm) for all four corner leads only.





## 18 LEAD CERAMIC DUAL-IN-LINE (300 MIL CDIP) D18



	INCHES		MILLIN		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А		0.200		5.08	
b	0.014	0.023	0.356	0.584	
b <sub>1</sub>	0.038	0.065	0.965	1.65	2
С	0.008	0.015	0.203	0.381	
D		0.960		24.38	4
E	0.220	0.310	5.59	7.87	4
E <sub>1</sub>	0.290	0.320	7.37	8.13	7
е	0.1	00 BSC	2.54 BSC		5
L	0.125	0.200	3.18	5.08	_
L <sub>1</sub>	0.150		3.81		—
Q	0.015	0.070	0.381	1.78	3
S		0.098		2.49	6
S <sub>1</sub>	0.005		0.13		6
α	0°	$15^{\circ}$	0°	15°	_

### NOTES

- 1. Index area; a notch or a lead one identification mark is located adjacent to lead one and is within the shaded area shown.
- 2. The minimum limit for dimension  $b_1$  may be 0.023 (0.58 mm) for all four corner leads only.
- 3. Dimension Q shall be measured from the seating plane to the base plane.
- 4. This dimension allows for off-center lid, meniscus and glass overrun.
- 5. The basic lead spacing is 0.100 inch (2.54 mm) between centerlines.
- 6. Applies to all four corners.
- 7. This is measured to outside of lead, not center.





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